

Panasonic

TVS Diode

DY2S24Z00L

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Silicon epitaxial planar type

For ESD protection and transient voltage suppressor

■ Features

- IEC 61000-4-2 (ESD) ± 8 kV (contact) / ± 15 kV (air)
- Low Clamping Voltage
- Low Capacitance
- Low Leak Current
- Halogen-free / RoHS compliant
(EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: XV

■ Packaging

Embossed type (Thermo-compression sealing) : 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Total power dissipation ^{*1}	PT	150	mW
Forward current	IF	100	mA
Electrostatic discharge ^{*2}	ESD	± 8	kV
Electrostatic discharge ^{*3}	ESD	± 15	kV
Peak pulse power ^{*4}	Ppp	87	W
Peak pulse current ^{*4}	Ipp	1.8	A
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C

Note: ^{*1} Mounted on glass epoxy print board. (45 mm x 45 mm x 1 mm)

Solder in. (0.8 mm x 0.6 mm)

^{*2} Test method: IEC61000_4_2

(C = 150 pF, R = 330 Ω , contact discharge: 10 times)

^{*3} Test method: IEC61000_4_2 (C = 150 pF, R = 330 Ω , air discharge: 10 times)

^{*4} Test method: IEC61000_4_5 (tp = 8/20 μs , Unrepeated)

■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	VF	IF = 10mA			1.0	V
Reverse stand-off voltage	VRWM	—			24.0	V
Reverse breakdown voltage ^{*1, *2}	VBR	IR = 2mA	25.7	27	28.4	V
Reverse current	IR	VR = 24V			0.01	μA
Clamping voltage ^{*3}	Vc	Ipp = 1.8A, tp = 8/20 μs			57.1	V
Terminal capacitance	Ct	VR = 0 V, f = 1 MHz		10		pF

Note: 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031

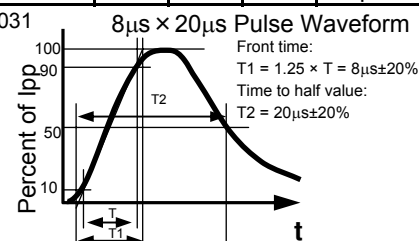
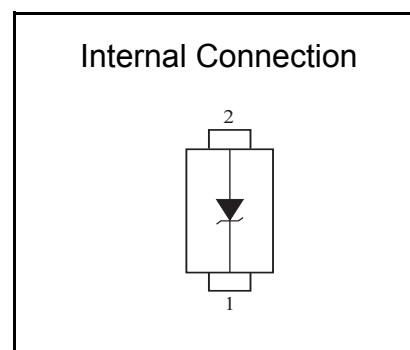
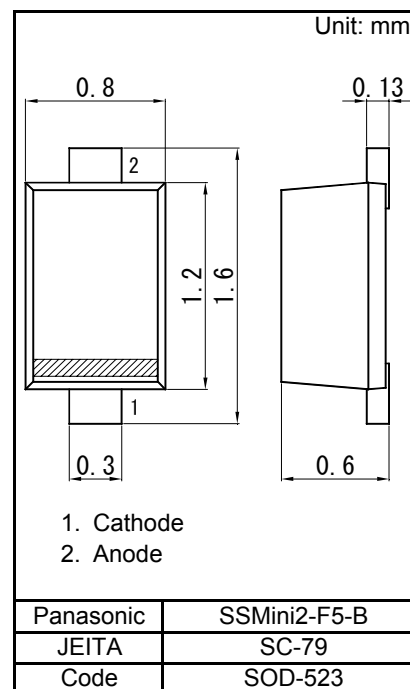
Measuring methods for Diodes.

2. Absolute frequency of input and output is 5 MHz.

3. ^{*1} The temperature must be controlled 25°C for VBR measurement.
VBR value measured at other temperature must be adjusted to VBR (25°C)

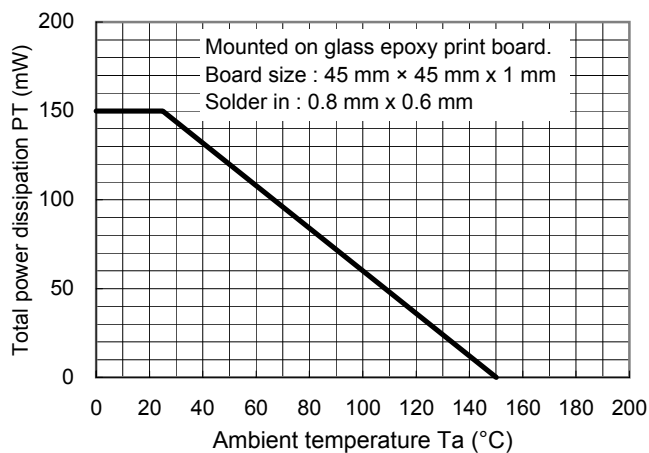
^{*2} VBR guaranteed 20 ms after current flow.

^{*3} 8 μs \times 20 μs Pulse Waveform

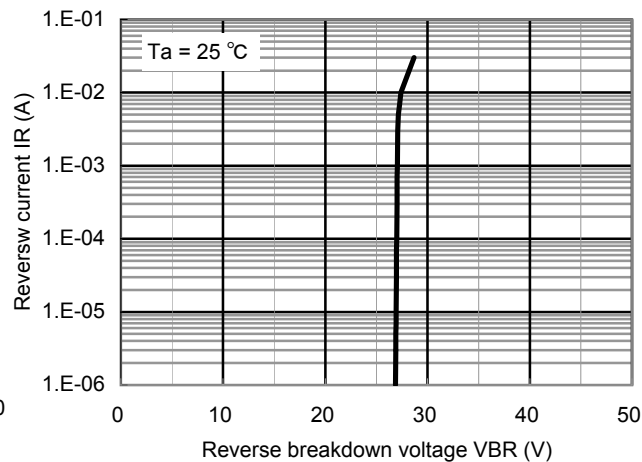


Technical Data (reference)

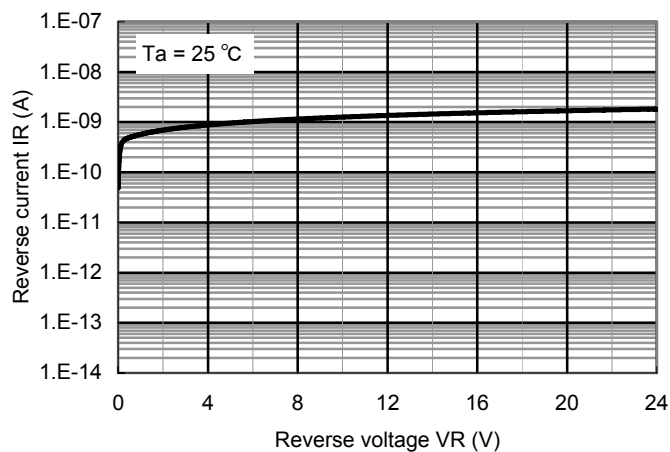
PT - Ta



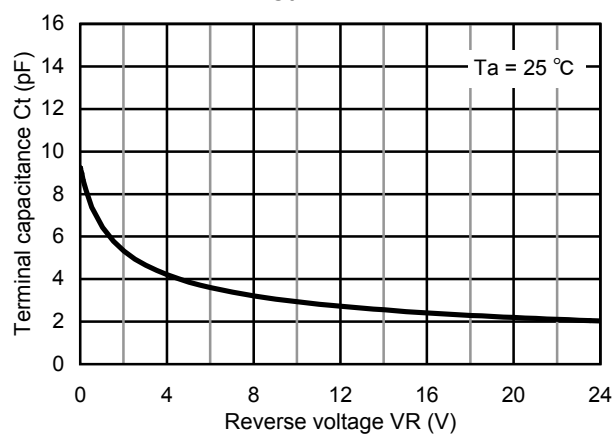
IR - VBR



IR - VR



Ct - VR

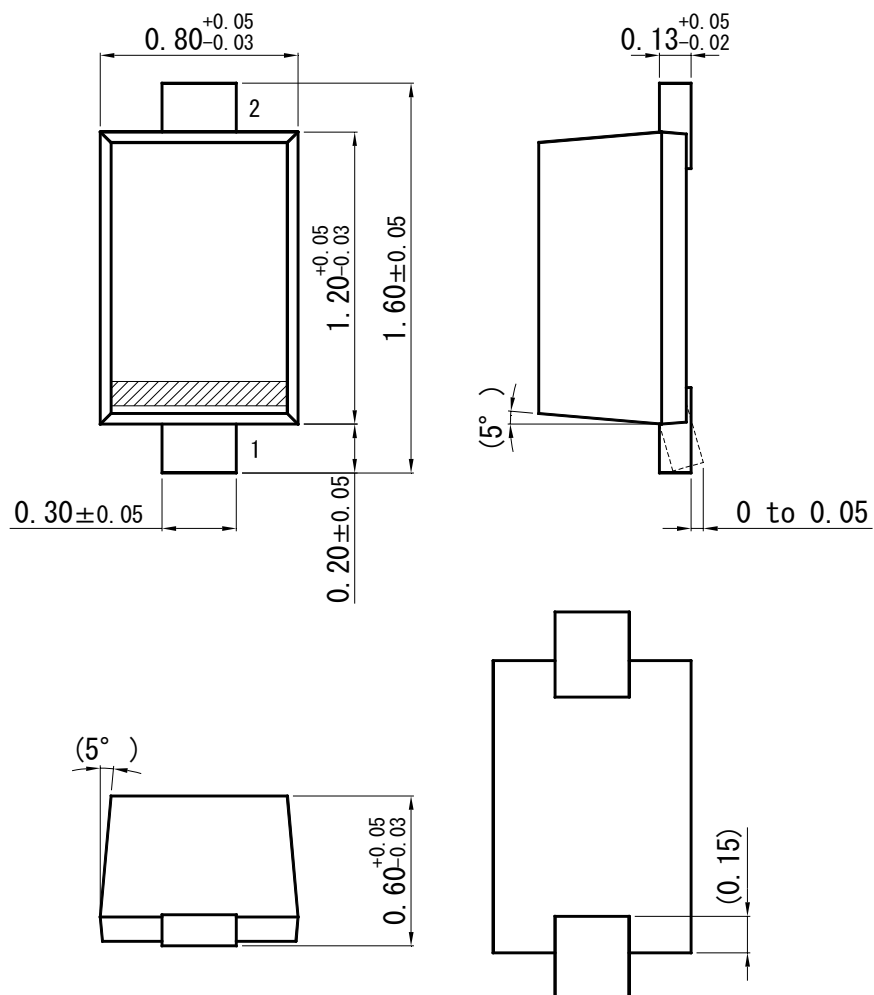


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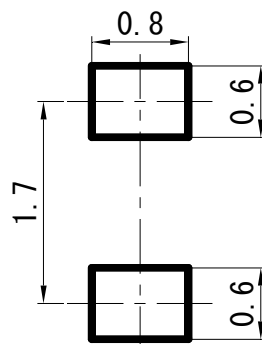
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SSMini2-F5-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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